High Speed Maskless Photolithography for Customized Nanomanufacturing

Michael E Walsh, Feng Zhang, Rajesh Menon¹, Henry I Smith LumArray Inc., 15 Ward St. Somerville MA, 02143 ¹now with University of Utah

The authors wish to thank DARPA, US Army, US Navy, and the National Science Foundation for sponsoring this work.



Why Lithography?

Lithography adds information, functionality to a system.

Pattern Generators vs. Pattern Replicators

e-beam lithography laser writers (e.g. Heidelberg) dip-pen lithography

Optical Projection Contact Printers Imprint Lithography Soft Lithography



Next Generation of What?

Key Metric **not** bleeding edge performance, but flexibility, cost, ease-of-use. <u>Access</u>.



• Research

- Defense
- Biotech (tissue scaffolds microarrays)
- Photonics, CGH
- Photomasks, inverse litho

ZPAL lowers barriers to entry for high-resolution lithography.

Barriers to Entry

LUMARRAY



Barriers to Entry

Complexity

LUMARRAY

Chemically Amplified Resist

Excimer Lasers

Tool Size, Footprint

Vacuum Proximity Effects

Inspection





Money & Time

Flexibility Non-Manhattan Geometries Large-area Devices

LUMARRAY

Photons Vs. Electrons

Long Wavelength Poor DOF Resolution Limit (???)

Short Wavelength

High resolution Depth of focus

LUMARRAY

Photons Vs. Electrons

But

Long Wavelength Poor DOF

Resolution Limit (???)

Fast & Cheap

Low Photon Energy No limit to photon density Ambient atmosphere Low-cost optics Photons unperturbed by fields Multi-beam is easy

Short Wavelength

High resolution Depth of focus

Very Challenging Engineering

Shot Noise in exposure dose Vaccum, Slow thermal stabilization **Deflection by ALL electric & magnetic fields!!!** beam current substrate charging column charging scanning stages

ZP-150A Alpha Tool

Affordable, high-throughput high-resolution patterning emphasizing flexibility and ease of use for research, prototyping and low-volume manufacturing.



Specifications Minimum Feature Size 150nm Dense, 120nm Isolated Numerical Aperture: NA=0.85 Parallel Beams: 1000 Writing Speed: 1.7mm²/sec (@0.85 NA) ~1hr per Ø100mm wafer, ~2hrs per Ø150mm wafer **Design Grid**: 1nm Positioning Resolution: 1.2nm Maximum Pattern Area 150mm x150mm <20nm Overlay Field Size: Unlimited Wavelength: 405nm (I-line, G-line compatible)

Field Size: Wavelength: Minienvironment: Pattern Layout: Optimization: Tool Size:

Unlimited 405nm (I-line, G-line compatible, ISO Class 5 GDS II MaskPlus PEC software 35" x53" x61"

LUMARRAY

Zone Plate: A Simple Diffractive Lens

Incident Radiation



Why diffractive optics?

- Abberation-free on-axis.
- High-NA at low cost.
- Fabricated with planar process.
- Focus uniformity across array.
- Wavefront engineering.



Zone-Plate-Array Lithography

LUMARRAY

Arbitrary patterns in a dot-matrix fashion as substrates are scanned beneath a fixed array of diffractive microlenses known as zone-plates.



Nanomanufacturing Summit 2009

Examples of ZPAL Patterns



LUMARRAY

Prototype MRAM memory





Array of contact holes

190 nm

Nanomanufacturing Summit 2009

ZP-150A System Overview

LUMARRAY



Advantages of ZPAL

- No Tradeof between resolution and field size
- Distortion-free independent of NA
- Incoherent Imaging (low k1, fast PEC)
- Fixed beam location enables great accuracy
- Easy i-line resist process
- Wavefront Engineering with Diffractive Optics

Pattern Optimization

Proprietary software ensures pattern fidelity, CD linearity by optimizing dose level to every pixel. Also corrects illumination inhomogeneity.



LUMARRAY

Proximity-Effect Correction

Uncorrected



~200 gray-levels for every exposure pixel allows sub-pixel line control

PEC is computationally easier for ZPAL (incoherent) than coherent imaging (e.g. projection litho).

Corrected

Design for Accuracy

Design

ILIMARRA

Benefit

Static Lens Array

Monolithic zone-plate array fixes relative positions of all beams on wafer.

Direct Metrology

ZPA, wafer chuck integrated in metrology frame with 2D encoder.

Position-clocked data

Timing of exposure determines location of exposed pixels on wafer



Loose Tolerances for beams to ZPA.

Location of beams on wafer determined only by stage position relative to ZPA.



Directly measures ZPA relative to wafer, not to machine frame

Reduces Abbe error,

- simplifies overall system.
- More robust than laser interferometer



The formal to scan are printed.



Position and velocity errors along scan compensated by exposure timing.

Problem of Inspection in Maskless Lithography

Inspection for direct-write litho is a harder problem than for photomasks.

Common to ALL maskless schemes.

- No Amortization
- No Repair
- Throughput requirement

Solution: Inspection on the fly

LUMARRAY

Hard Output

Record in photoresist of dose • at all positions on substrate. Soft Output

Digital record of dose at all positions on susbstrate.

- ★ Tool provides additional soft output to enable localization and characterization of errors prior to guide inspection of hard output.
- Capture of true position of all beams simultaneously with dose information critical for practical implementation.

Absorbance Modulation Optical Lithography (AMOL)



R. Menon, et al, J. Opt. Soc. Am A, 23, 2290 (2006).

LUMARRAY

- Annulus at λ_2 in competition with bright spot at λ_1 creates localized sub-wavelength aperture
- Bright spot at λ_1 transmits through aperture exposing photoresist

AMOL Proof-of-Concept

Dichromatic Zone Plate

LUMARRAY

Absorbance Modulation Photochemistry



Thanks to H.Y. Tsai, Massachusetts Institute of Technology and T. Andrew, Massachusetts Institute of Technology



Zone-Plate Array Lithography

Wafer-scale patterning with near e-beam resolution. Turnaround in hours, not days or weeks.

Thanks to : DARPA US Army US Navy NSF MIT NanoStructures Lab Trisha Edwards University of Utah



State-of-the-art



Laser Pattern Generator

Electron Beam



Scanning System

Only Cross-Scan error, not along scan, contributes to pattern error

- Custom XY Air Bearing onGranite Base
- Inm resolution at 20MHz
- 2kHz Control Loop

LUMARRAY





Interferometric Spatial-Phase Imaging

ISPI encodes position in the spatial-phase disparity between a matched pair of interferometric moiré patterns that magnify displacement.





LUMARRAY

Benefits of ISPI

Directly measure working distance. Direct ZPA-wafer overlay. Dark Field Imaging for High-SNR. Low-NA (0.06) optics. Robust through multiple layers.

E.E. Moon et al, J. Vac Sci. Technol. B 21(6) 3112 (2003)